

C0805C102F2GEC

ESD SMD Comm COG, Ceramic, 1,000 pF, 1%, 200 VDC, COG, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 0805, 0.7 mm



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General Information	
Series	ESD SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I
Features	Temperature Stable, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	13 mg
Shelf Life	78 Weeks
MSL	1

0805
2mm +/-0.2mm
1.25mm +/-0.2mm
0.9mm +/-0.10mm
0.7mm MIN
0.5mm +/-0.25mm

Bulk, Bag

1

Packaging Specifications

Packaging Packaging Quantity

Specifications Capacitance 1,000 pF **Measurement Condition** 1 MHz 1.0Vrms Tolerance 1% 200 VDC Voltage DC ESD Level per AEC-Q200 8,000 V ESD Level **Dielectric Withstanding Voltage** 500 VDC **Temperature Range** -55/+125°C Temp. Coefficient COG Capacitance Change with Reference to +25°C and 0 VDC 30 ppm/C, 1MegaHz 1.0Vrms Applied (TCC) **Dissipation Factor** 0.1% 1 MHz 1.0Vrms Aging Rate 0% Loss/Decade Hour Insulation Resistance 100 GOhms

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